

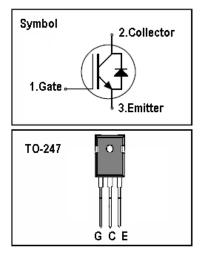
## IGBT

### Features

- 1200V,15A
- V<sub>CE(sat)(typ.)</sub>=2.2V@V<sub>GE</sub>=15V,I<sub>C</sub>=15A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA using NPT technology

### **General Description**

JIAEN NPT IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating),UPS, general inverter and other soft switching applications.



## Absolute Maximum Ratings

| Symbol           | Parameter   | Value       | Units |  |
|------------------|---|-------------|-------|--|
| Vces             | Collector-Emitter Voltage   | 1200        | V     |  |
| V <sub>GES</sub> | Gate-Emitter Voltage  | <u>+</u> 20 | V     |  |
|                  | Continuous Collector Current (Tc=25 °C)                             | 30          | A     |  |
| lc               | Continuous Collector Current (Tc=100°C)                             | 15          | А     |  |
| Ісм              | Pulsed Collector Current (Note 1)                                   | 45          | A     |  |
| lF               | Diode Continuous Forward Current ( Tc=100 ℃)                        | 15          | A     |  |
| lfм              | Diode Maximum Forward Current (Note 1)                              | 45          | А     |  |
| t <sub>sc</sub>  | Short Circuit Withstand Time  | 10          | us    |  |
| D-               | Maximum Power Dissipation (Tc=25 °C)                                | 180         | W     |  |
| PD               | P <sub>D</sub><br>Maximum Power Dissipation (T <sub>c</sub> =100°C) |             | W     |  |
| TJ               | Operating Junction Temperature Range                                | -55 to +150 | °C    |  |
| Tstg             | Storage Temperature Range   | -55 to +150 | °C    |  |

### **Thermal Characteristics**

| Symbol              | Parameter  | Max. | Units |  |
|---------------------|--|------|-------|--|
| Rth j-c             | Rth j-c Thermal Resistance, Junction to case for IGBT              |      | °C/W  |  |
| Rth j-c             | R <sub>th j-c</sub> Thermal Resistance, Junction to case for Diode |      | °C/W  |  |
| R <sub>th j-a</sub> | Rth j-a Thermal Resistance, Junction to Ambient                    |      | °C/W  |  |



### Electrical Characteristics (Tc=25°C unless otherwise noted )

| Symbol               | Parameter                            | Test Conditions   | Min. | Тур. | Max. | Units |
|----------------------|--------------------------------------|---|------|------|------|-------|
| BV <sub>CES</sub>    | Collector-Emitter Breakdown Voltage  | V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA  | 1200 | -    | -    | V     |
| I <sub>CES</sub>     | Collector-Emitter Leakage Current    | V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V   | -    | -    | 250  | uA    |
|                      | Gate Leakage Current, Forward        | $V_{GE}$ =30V, $V_{CE}$ = 0V  | -    | -    | 100  | nA    |
| I <sub>GES</sub>     | Gate Leakage Current, Reverse        | $V_{GE}$ = -30V, $V_{CE}$ = 0V  | -    | -    | -100 | nA    |
| $V_{GE(th)}$         | Gate Threshold Voltage               | $V_{GE} = V_{CE}, I_C = 250 \text{uA}$  | 4    | -    | 6    | V     |
| V <sub>CE(sat)</sub> | Collector-Emitter Saturation Voltage | V <sub>GE</sub> =15V, I <sub>C</sub> = 15A  | -    | 2.2  | 2.7  | V     |
| Qg                   | Total Gate Charge                    | Vcc=960V  | -    | 70   |      | nC    |
| Qge                  | Gate-Emitter Charge                  | V <sub>GE</sub> =15V<br>I <sub>C</sub> =15A   | -    | 23   |      | nC    |
| Q <sub>gc</sub>      | Gate-Collector Charge                |   | -    | 24   |      | nC    |
| t d(on)              | Turn-on Delay Time                   |   | -    | 30   | -    | ns    |
| t r                  | Turn-on Rise Time                    | V <sub>cc</sub> =600V<br>V <sub>GE</sub> =15V<br>I <sub>c</sub> =15A<br>R <sub>G</sub> =28Ω<br>Inductive Load<br>T <sub>c</sub> =25 ℃ | -    | 35   | -    | ns    |
| t d(off)             | Turn-off Delay Time                  |   | -    | 260  | -    | ns    |
| t f                  | Turn-off Fall Time                   |   | -    | 135  | -    | ns    |
| Eon                  | Turn-on Switching Loss               |   | -    | 1.3  | -    | mJ    |
| Eoff                 | Turn-off Switching Loss              |   | -    | 0.9  | -    | mJ    |
| Ets                  | Total Switching Loss                 |   | -    | 2.2  | -    | mJ    |
| Cies                 | Input Capacitance                    | V <sub>CE</sub> =25V  | -    | 550  | -    | pF    |
| Coes                 | Output Capacitance                   | V <sub>GE</sub> =0V   | -    | 180  | -    | pF    |
| Cres                 | Reverse Transfer Capacitance         | f = 100kHz  | -    | 110  | -    | pF    |

### Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

| Symbol         | Parameter                           | Test Conditions        | Min. | Тур. | Max. | Units |
|----------------|-------------------------------------|------------------------|------|------|------|-------|
| V <sub>F</sub> | Diode Forward Voltage               | I <sub>F</sub> =15A    | -    | 2.3  | 2.8  | V     |
| trr            | Diode Reverse Recovery Time         | V <sub>CE</sub> = 600V | -    | 240  |      | ns    |
| lrr            | Diode peak Reverse Recovery Current | I <sub>F</sub> = 15A   | -    | 13   |      | А     |
| Qr r           | Diode Reverse Recovery Charge       | dIF/dt = 400A/us       | -    | 2000 |      | nC    |

### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



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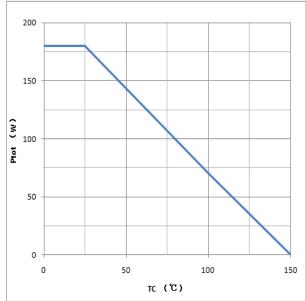
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## **JNG15N120HS2**

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**Typical Performance Characteristics** 



## Figure1:maximum DC collector current VS. case temprature

TC (°ී)

100

50

Figure2:power dissipation VS. case temprature

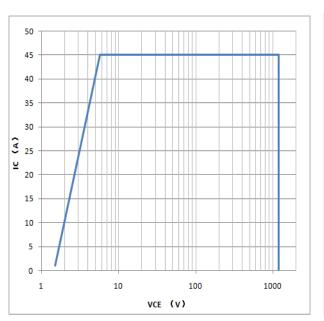
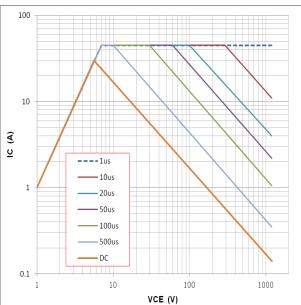
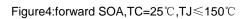


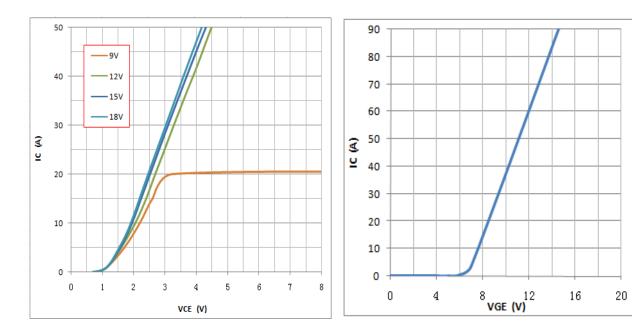
Figure3:reverse bias SOA,TJ=150°C,VGE=15V





150





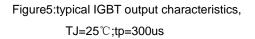
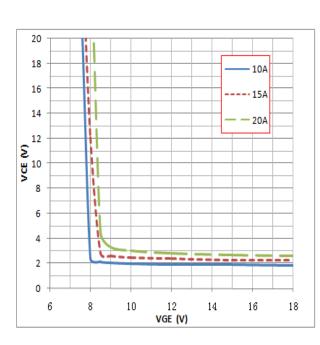


Figure6:typical trans characteristics,VCE=20V,tp=20us



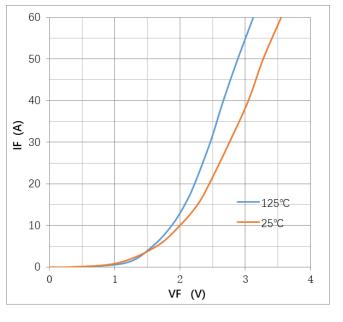


Figure7: typical VCE VS. VGE,TJ=25°C

Figure8:typical diode forward characteristic,tp=300us



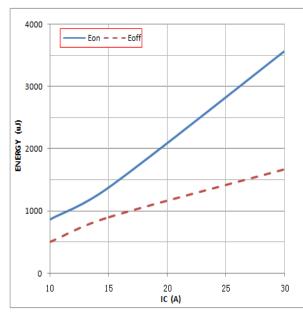


Figure9: typical energy loss VS. IC, TC=25  $^\circ\!C$ , L=500uH, VCE=600V,VGE=15V,Rg=28  $^\Omega$ 

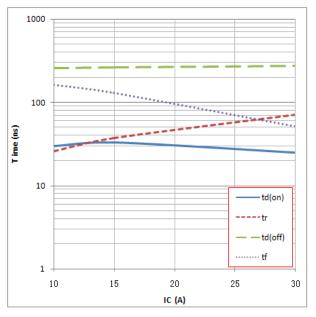


Figure10: typical switching time VS. IC, TC=25 $^\circ\!\mathrm{C}$ , L=500uH, VCE=600V,VGE=15V,Rg=28 $\Omega$ 

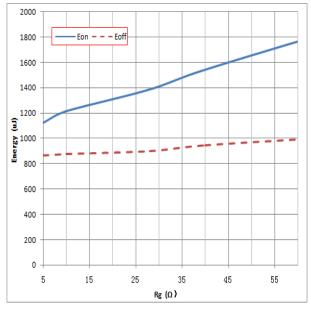
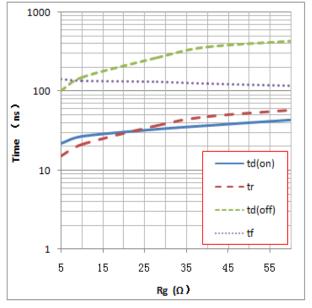
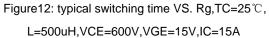
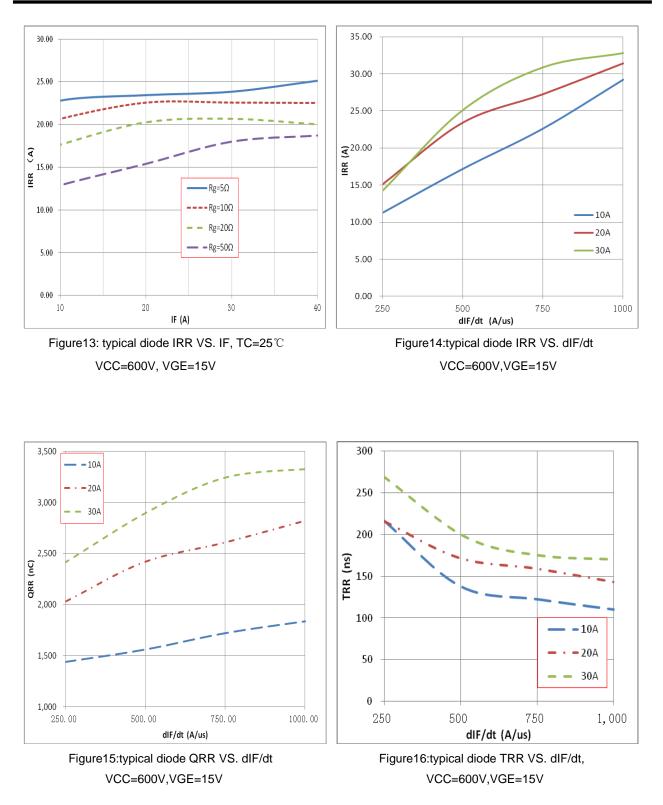


Figure11: typical energy loss VS. Rg,TC=25 $^{\circ}$ C, L=500uH, VCE=600V, VGE=15V,IC=15A











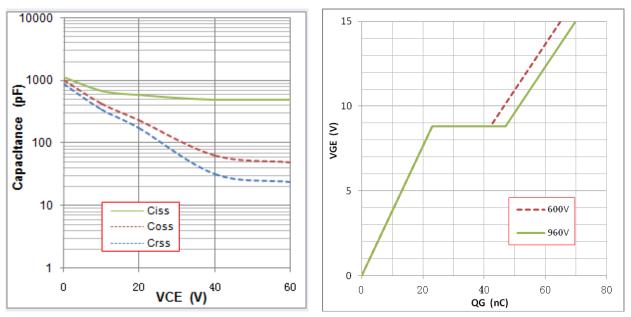
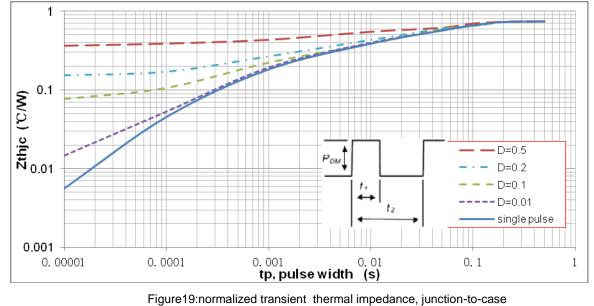


Figure17:typical capacitance VS. VCE,VGE=0V,f=100kHz Fig

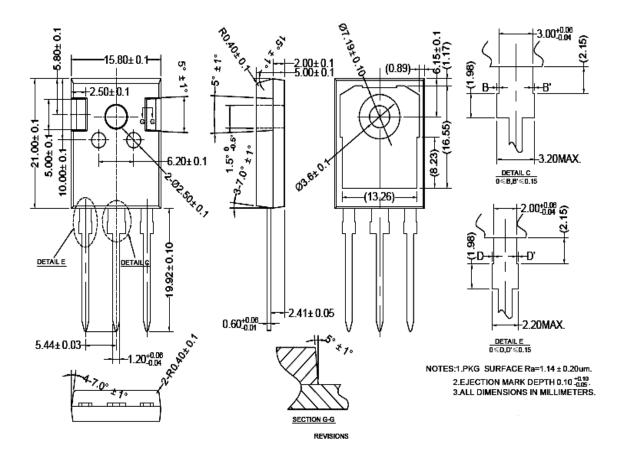
Figure18:typical gate charge VS. VGE,IC=15A



Note1.Duty factor D=t1/t2; Note2:peak TJ=PDM×Zthjc+TC



### **TO247 PACKAGE OUTLINE**



| 会差标注   | 公差值    | 表面粗糙度     |
|--------|--------|-----------|
| 0      | ±0.2   | Ra3.2~6.3 |
| 0.0    | ±0.1   | Ra1.6~3.2 |
| 0.00   | ±0.01  | Ra0.8~1.6 |
| 0.000  | ±0.005 | Ra0.4~0.8 |
| 0.0000 | ±0.002 | Ra0.2~0.4 |

#### 0≤D,D'≤0.15

NOTES:1.PKG\_SURFACE Ra=1.14 ± 0.20um. 2.EJECTION MARK DEPTH 0.10 +0.10 -0.05 3.ALL DIMENSIONS IN MILLIMETERS.



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